Photo Couplers Panasonic

CND0208A

Infrared Optocal Module (IrDA)

Infrared data link for cellular phones, peripheral devices

■ Features

- Compliant with IrDA Ver.1.2
- Reception distance: 50 cm
- Corresponding reflow solder (260°C)
- Ultra-small top view package (2.0 mm \times 7.2 mm \times 1.7 mm)

■ Type

• GaAlAs LED + IC + PIN Photodiode

■ Absolute Maximum Ratings $T_a = 25$ °C±3°C

Parameter	Symbol	Rating	Unit	
Operating supply voltage	V _{CC}	-0.5 to +3.8	V	
Output voltage	Vo	-0.5 to $+3.8$	V	
Input voltage	$V_{\rm I}$	-0.5 to $+3.8$	V	
Shutdown input voltage	V_{SD}	-0.5 to $+3.8$	V	
LED operating supply voltage	V_{LEDA}	-0.5 to $+7.0$	V	
Pulse forward current *	I_{FP}	300	mA	
Low level output current	I_{OL}	10	mA	
Operating ambient temperature	T _{opr}	-20 to +70	°C	
Storage temperature	T _{stg}	-30 to +85	°C	

Note) *: $tw \le 90 \mu s$, $Duty \le 25 \%$

■ Operation Condition

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Operating supply voltage	V _{CC}		2.4	2.8	3.3	V
LED operating supply voltage	V_{LEDA}		2.6		4.2	V

■ Electrical-Optical Characteristics $V_{CC} = 2.8 \text{ V}, T_a = 25 \text{°C} \pm 3 \text{°C}$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
High level supply current *1	I_{CCH}	$V_{TXD} = 0.5 \text{ V}, V_{SD} \le 0.5 \text{ V}$		90	120	μΑ
Low level supply current *1	I_{CCL}	$V_{TXD} = 0.5 \text{ V}, V_{SD} \le 0.5 \text{ V}$		150	360	μΑ
Shut down supply current *1	I _{CCSD}	$V_{CC} \ge V_{SD} \ge V_{CC} - 0.3 \text{ (SD = High)}$ $V_{TXD} = 0.5 \text{ V}$		10	200	nA
Maximum reception distance *4	L _{max}	$V_{LED} = V_{CC} = 2.6 \text{ V}, V_{SD} \le 0.5 \text{ V},$ External components	50			cm
Data Rates	_		9.6		115.2	kbps

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\blacksquare Electrical-Optical Characteristics (Continued) V_{CC} = 2.8 V, T_a = 25°C±3°C

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Transmitter							
Peak emission wavelength *1		$\lambda_{ m P}$	$V_{SD} \le 0.5 \text{ V}, V_{LED} = 3.2 \text{ V Duty } 3/16$	878	883	888	nm
			$V_{SD} \le 0.5 \text{ V}, V_{LED} = 3.2 \text{ V Duty } 3/16$ $T_a = -20^{\circ}\text{C to } +70^{\circ}\text{C}$	850	883	900	nm
Pulse forward current *1		I_{FP}	$V_{LED} = V_{CC} = 3.1 \text{ V}, V_{SD} \le 0.5 \text{ V}$ TXD Duty 3/16	100	135	150	mA
Center radiant intensity *1, 2, 9	$\theta_T = 0$	I _e	$V_{LED} = V_{CC} = 2.6 \text{ V}, V_{SD} \le 0.5 \text{ V}$ TXD Duty 3/16	20	35		mW/sr
	$\theta_{\rm T} = \pm 15$	I _{e15}	$V_{LED} = V_{CC} = 2.6 \text{ V}, V_{SD} \le 0.5 \text{ V}$ TXD Duty 3/16	14.5			mW/sr
High level input voltage *1		V_{IH}	$V_{LED} = 3.2 V$	$V_{CC} - 0.3$		V _{CC}	V
Low level input voltage *1		$V_{\rm IL}$	$V_{LED} = 3.2 V$	0		0.5	V
TX half-angle		θ_{T}		±15			0
Rise time *1,3		t _r	$V_{LED} = 3.2 \text{ V}, t_w = 1.6 \mu\text{s}, R_L = 50 \Omega$		0.3	0.6	μs
Fall time *1,3		t_{f}	$V_{LED} = 3.2 \text{ V}, t_w = 1.6 \mu\text{s}, R_L = 50 \Omega$		0.3	0.6	μs
TX wake up time *7		t _{Twu}			0.3	1	μs
Intensity delay time *1,3		I _{DT}	$V_{LED} = 3.2 \text{ V}$			200	ns
Maximum pulse width		T _{wLEDmax}	$TXD = Low \rightarrow High$	20	50	100	μs
Overshoot		O_S				25	%
Edge jitter		E_{J}		-40		40	ns
Receiver							
Minimum input irradiance		E _{I min}	$V_{LED} = V_{CC} = 2.6 \text{ V}, V_{SD} \le 0.5 \text{ V}$			5.8	μW/cm ²
Maximum input irradiance		E _{I max}	$V_{SD} \le 0.5 \text{ V}$	500			mW/cm ²
High level output voltage *5		V _{OH}	Non signal condition $I_{OH} = -200~\mu A, V_{SD} \leq 0.5~V$	V _{CC} -0.3		V _{CC}	V
Low level output voltage *6		V _{OL}	$I_{OL} = 500 \mu\text{A}, V_{SD} \le 0.5 \text{V}$	0		0.5	V
RX half angle		θ_{R}		±15			0
RXD output pulse width		T _{WR}	$C_L = 15 \text{ pF}, 9.6 \text{ kbps to } 115.2 \text{ kbps}$	1.0	2.3	4.2	μs
RX wake up time *8		t _{Rwu}	$E_I = 8.1 \ \mu \text{W/cm}^2$		200	400	μs
Receiver latency time		$t_{ m L}$	$E_I = 8.1 \mu\text{W/cm}^2$		100	200	μs
Rise time		t _r	$C_L = 15 \text{ pF}$			300	ns
Fall time		t_{f}	$C_L = 15 \text{ pF}$			300	ns

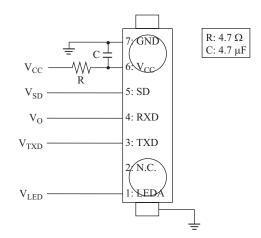
2 SHF00009AEK

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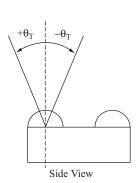
■ Electrical-Optical Characteristics (Continued)

Note) Measuring circuit

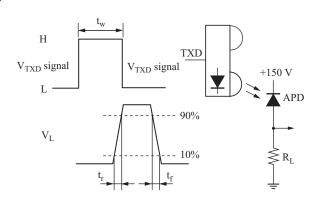
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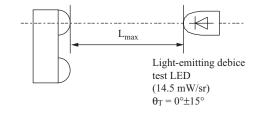
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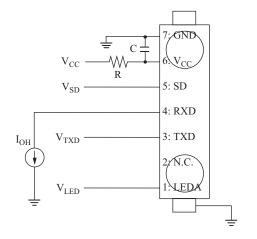
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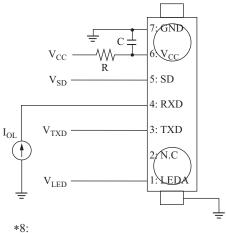
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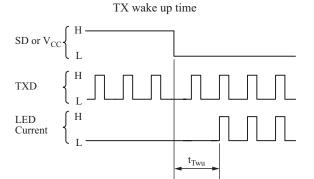
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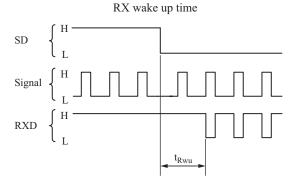


*6:



*7:



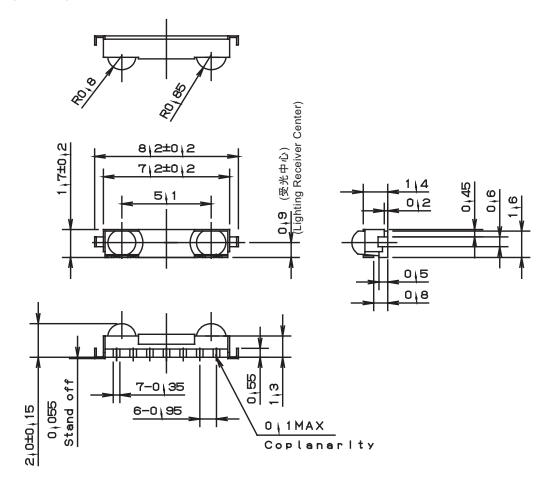


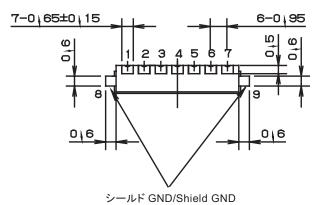
*9: Eye-Safety IEC60825-1 Class1 Eye safe

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■ Package (Unit: mm)





• Pin name

1. LEDA 6. V_{CC}

2. N.C. 7. GND

3. TXD 8. Shield GND

4. RXD 9. Shield GND

5. SD



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GaAs powder and vapor are hazardous to human health if inhaled or ingested. Do not burn, destroy, cut, cleave off, or chemically dissolve the product. Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

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